

FYPF1545DN

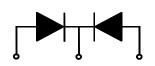
Features

- · Low forward voltage drop
- High frequency properties and switching speed
- Guard ring for over-voltage protection

Applications

- Switched mode power supply
- Freewheeling diodes





1. Anode 2. Cathode 3. Anode

SCHOTTKY BARRIER RECTIFIER

Absolute Maximum Ratings T_C=25°C unless otherwise noted

| Symbol | Parameter | Value | Units |
|----------------------------------|--|-------------|-------|
| V _{RRM} | Maximum Repetitive Reverse Voltage | 45 | V |
| V _R | Maximum DC Reverse Voltage | 45 | V |
| I _{F(AV)} | Average Rectified Forward Current @ T _C = 110°C | 15 | А |
| I _{FSM} | Non-repetitive Peak Surge Current (per diode) 60Hz Single Half-Sine Wave | 100 | А |
| T _{J,} T _{STG} | Operating Junction and Storage Temperature | -65 to +150 | °C |

Thermal Characteristics

| Symbol Parameter | | Value | Units |
|------------------|--|-------|-------|
| $R_{\theta JC}$ | Maximum Thermal Resistance, Junction to Case (per diode) | 4.0 | °C/W |

Electrical Characteristics (per diode)

| Symbol | Parameter | Value | Units | |
|-------------------|---------------------------------------|---|-------|----|
| V _{FM} * | Maximum Instantaneous Forward Voltage | | | V |
| | I _F = 7.5A | $T_C = 25 ^{\circ}C$ | 0.55 | |
| | I _F = 7.5A | $T_C = 25 ^{\circ}C$ $T_C = 125 ^{\circ}C$ | 0.49 | |
| | I _F = 15A | T _C = 25 °C T _C = 125 °C | 0.70 | |
| | I _F = 15A | T _C = 125 °C | 0.65 | |
| I _{RM} * | Maximum Instantaneous Reverse Current | | | mA |
| | @ rated V _R | T _C = 25 °C | 1 | |
| | | $T_C = 25$ °C $T_C = 125$ °C | 60 | |

^{*} Pulse Test: Pulse Width=300µs, Duty Cycle=2%

Typical Characteristics

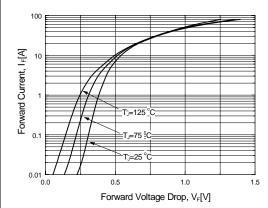


Figure 1. Typical Forward Voltage Characteristics (per diode)

1000 900 800

> 500 400 300

> 200

Juntion Capacitance, C _[pF]



Figure 3. Typical Junction Capacitance (per diode)

20

Reverse Voltage, V_R[V]

30

40

10

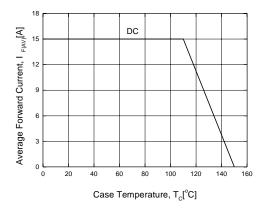


Figure 5. Forward Current Derating Curve

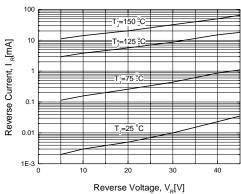


Figure 2. Typical Reverse Current vs. Reverse Voltage (per diode)

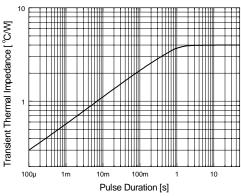


Figure 4. Thermal Impedance Characteristics (per diode)

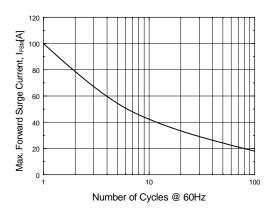
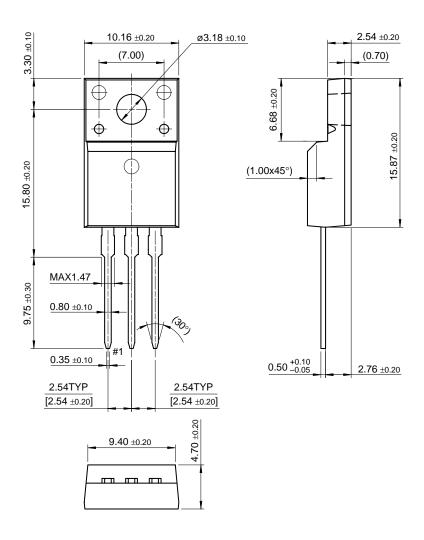


Figure 6. Non-Repetitive Surge Current (per diode)

Package Dimensions

TO-220F



Dimensions in Millimeters

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